

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Device Features

- +5V/680mA at operating bias condition
- Gain = 27.3 dB @ 1850 MHz
- P1dB = 33.1 dBm @ 1850MHz
- LTE 10M ACLR = 23.5dBm Output Power at -50dBc @ 1850MHz
- Intergrated interstage matching
- Lead-free/Green/RoHS-compliant QFN5x5 SMT package

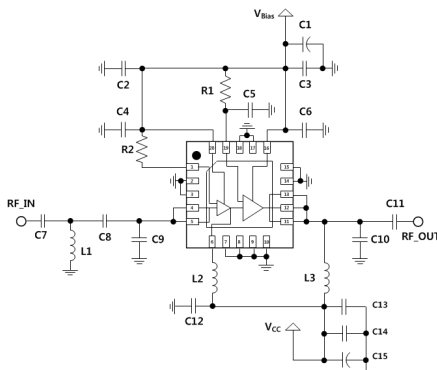
Product Description

The BMT332 is a high dynamic range two-stage power amplifier housed in RoHS compliant 20 pin, 5x5mm QFN package. The BMT332 uses a high reliability InGaP/GaAs HBT process technology. The BMT332 is designed for use where high linearity and gain is required. The BMT332 is able to deliver over 23 dBm output power from 700 to 2400MHz while maintaining superior ACLR performance with a few external matching components. All devices are 100% RF/DC screened.

Applications

- Base station /Repeaters Infrastructure
- Commercial/Industrial/Military wireless system
- LTE / WCDMA /CDMA Wireless Infrastructure

Application Circuits



*external matching circuit: refer to the page 4 to 19.

Typical Performance¹

Parameter	Frequency						Unit
	850	1750	1850	1960	2140	2350	
Gain	33.5	28.0	27.3	26.7	26.0	24.0	dB
S11	-18.0	-30.0	-30.0	-26.0	-17.0	-17.0	dB
S22	-14.5	-11.5	-11.5	-12.0	-11.0	-12.5	dB
OIP3 ²	50.0	50.0	49.0	49.0	47.5	47.5	dBm
P1dB	33.6	33.2	33.1	33.1	33.2	33.1	dBm
LTE 10M ACLR	23.4	23.4	23.5	23.2	23.8	23.2	dBm
WCDMA ACLR	23.5	23.7	23.7	23.5	24.0	23.5	dBm
Noise Figure	7.0	5.6	5.6	5.5	5.5	5.3	dB

¹ Device performance _ measured on a BeRex evaluation board at 25°C, 50 Ω

² OIP3 _ measured on two tones with a output power 23dBm/ tone , F2-F1 = 1 MHz..

*ACLR Channel Power measured at -50dBc.

- LTE set-up: 3GPP LTE, FDD E-TM3.1, 10MHz BW, ±5MHz offset, PAR 9.75 @0.01% Prob.

- WCDMA set-up: 3GPP WCDMA, TM1+64DPCH, +5MHz offset, PAR 9.78 at 0.01% Prob.

	Min.	Typical	Max.	Unit
Bandwidth	700		2400	MHz
I _{bias} @ (I _{REF1&2} + I _{B1&2})		33		mA
I _C @ (I _{C1} + I _{C2})		680		mA
V _{CC} /V _{Bias}		5.0		V
R _{TH}		7.9		°C/W

Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+200	°C
Operating Voltage	+6	V
Supply Current	2000	mA
Input RF Power	23	dBm

*Operation of this device above any of these parameters may result in permanent damage.

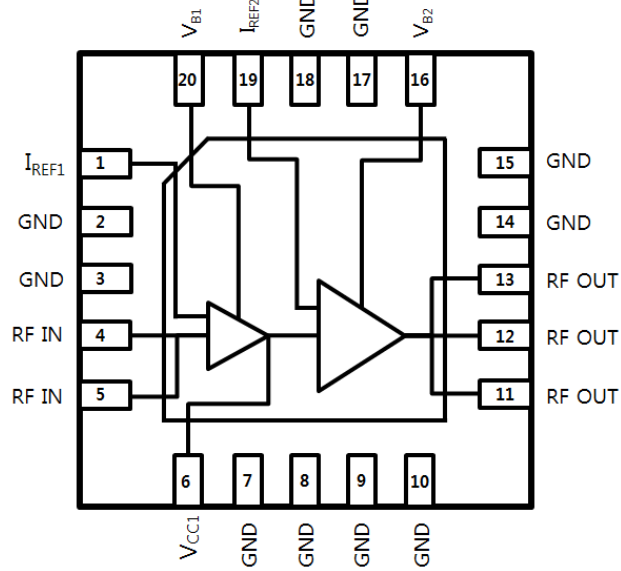
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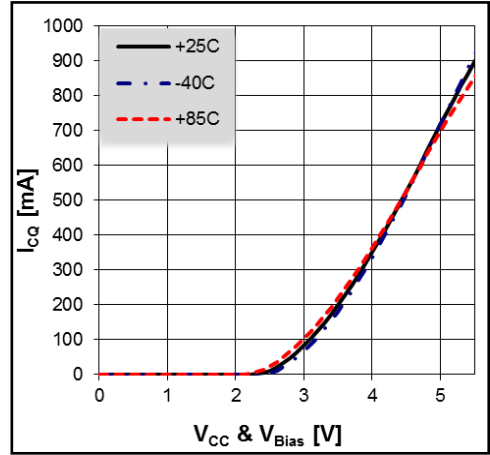
Preliminary Datasheet

Pin Configuration



Pin No.	Label
1	I _{REF1}
4,5	RF IN
6	V _{CC1}
11,12,13	RF OUT/V _{CC2}
16	V _{B2}
19	I _{REF2}
20	V _{B1}
2,3,7,8,9,10,14, 15,17,18	GND
Backside Paddle	GND

V-I Characteristics



BeRex Evaluation Board

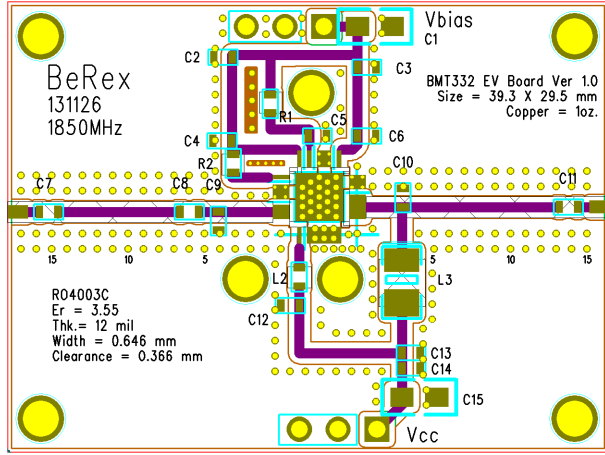
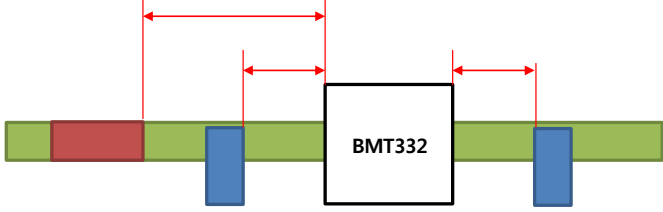


Figure about the reference position of components



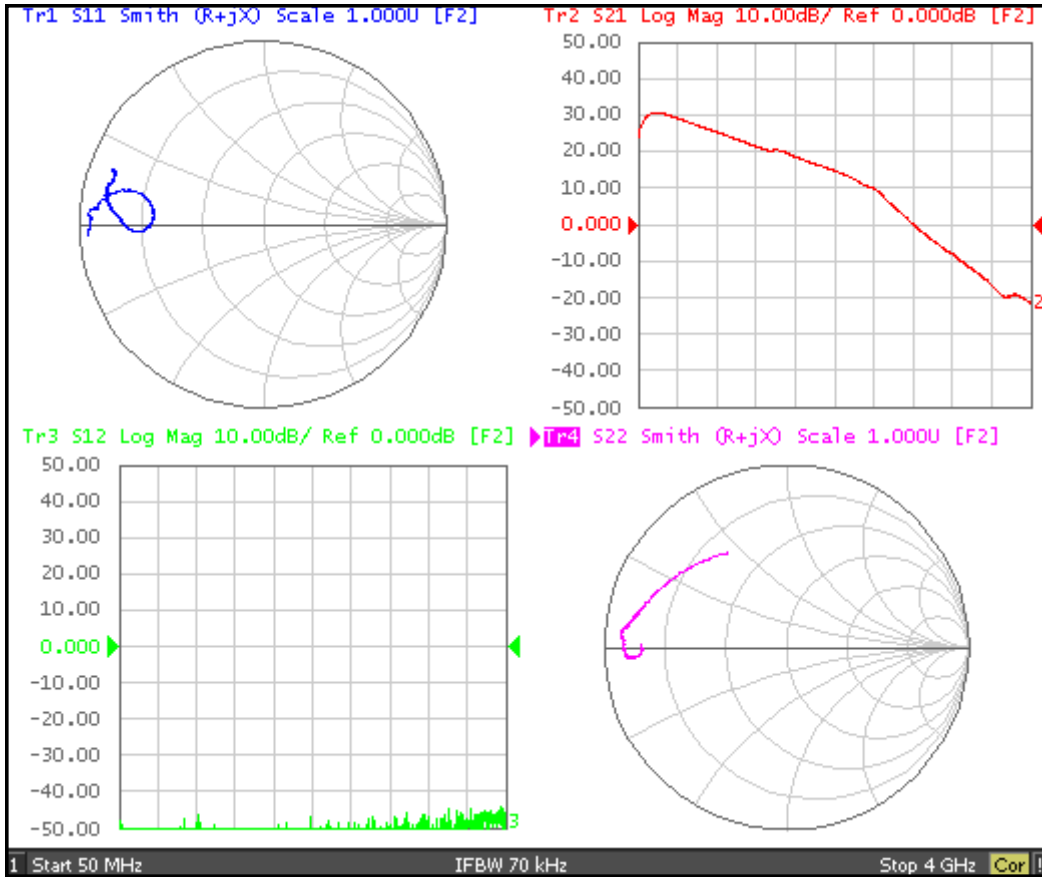
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700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Typical Device Data

S-parameters (V_{cc} & V_{Bias} = +5V, I_{cq} =680mA, T_a =25°C)



S-Parameter

(V_{cc} & V_{Bias} = +5V, I_{cq} = 680mA, T_a = 25 °C, calibrated to device leads)

Freq [MHz]	S11 [Mag]	S11 [Ang]	S21 [Mag]	S21 [Ang]	S12 [Mag]	S12 [Ang]	S22 [Mag]	S22 [Ang]
100	0.913	173.761	24.816	32.166	0.003	79.828	0.801	-178.428
500	0.619	171.121	26.921	-92.025	0.001	-44.058	0.869	-176.093
1000	0.701	-177.176	15.441	-178.364	0.002	59.383	0.879	-177.489
1500	0.784	177.684	10.073	107.582	0.001	119.430	0.895	179.724
2000	0.826	174.821	5.629	28.494	0.001	52.589	0.901	177.048
2500	0.877	167.581	2.533	-60.751	0.002	52.748	0.909	174.926
3000	0.856	164.082	0.614	-113.048	0.003	73.959	0.876	171.808
3500	0.863	160.570	0.198	-148.521	0.002	48.291	0.800	161.758
4000	0.868	160.252	0.085	179.517	0.004	44.770	0.607	121.233

Preliminary Datasheet

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Application Circuit: 850 MHz

Preliminary Datasheet

Schematic Diagram	BOM		Marks	
	C1	1206	10uF	Tantalum
	C2	0603	N/A	
	C3	0603	68pF	
	C4	0603	1nF	
	C5	0603	N/A	
	C6	0603	3.3pF	
	C7	0603	100pF	
	C8	0603	5pF	
	C9	0603	N/A	
	C10	0603	10pF	High Q
	C11	0603	100pF	
	C12	0603	1uF	
	C13	0603	100pF	
	C14	0603	1nF	
	C15	1206	10uF	Tantalum
L1	0603	5.6nH		
L2	0603	22nH		
L3	1008	22nH	Coil	
R1	0603	100 Ω	±5%	
R2	0603	270 Ω	±5%	

PCB Diagram	Notice																					
<p>BeRex 131126 850MHz</p> <p>BMT332 EV Board Ver 1.0 Size = 39.3 X 29.5 mm Copper = 1oz.</p> <p>R04003C Er = 3.55 Thk. = 12 mil Width = 0.646 mm Clearance = 0.366 mm</p>	<p>Below information is subject to change as conditions of the substrate.</p> <table border="1"> <thead> <tr> <th>Reference</th> <th>Object</th> <th>Distance</th> </tr> </thead> <tbody> <tr> <td>Input pin</td> <td>L1</td> <td>8.0mm</td> </tr> <tr> <td>Input pin</td> <td>C8</td> <td>5.3mm</td> </tr> <tr> <td>Output pin</td> <td>C10</td> <td>9.0mm</td> </tr> <tr> <td>Pin 16</td> <td>C3</td> <td>7.2mm</td> </tr> <tr> <td>Pin 16</td> <td>C6</td> <td>2.0mm</td> </tr> <tr> <td>Pin 20</td> <td>C4</td> <td>5.0mm</td> </tr> </tbody> </table> <ol style="list-style-type: none"> Pin 16 & 20 is used for Vce of the inner bias circuit. To eliminate bias line resonance you need above 10mm transmission line and adjust the position of C2, C3, C4, C5 and C6. Also you can adjust spectrum regrowth about bandwidth of signals which you want. C10 : We recommend High-Q capacitor for better output power performance. In this document we used '10pF(251R14S100JV4, EIA 0603) of Johanson Technology. You could change C7 from 100 pF to 0 Ω or a line if you have other DC block front of BMT332. 	Reference	Object	Distance	Input pin	L1	8.0mm	Input pin	C8	5.3mm	Output pin	C10	9.0mm	Pin 16	C3	7.2mm	Pin 16	C6	2.0mm	Pin 20	C4	5.0mm
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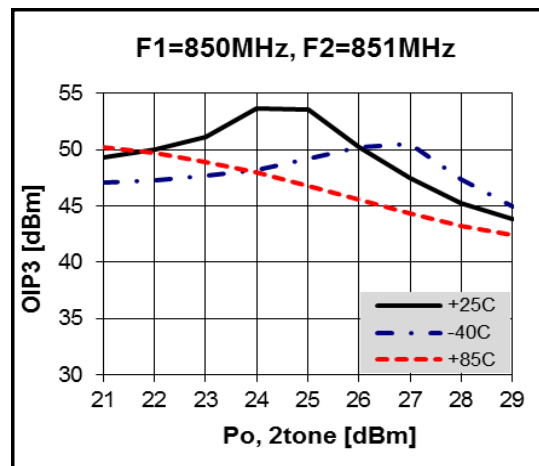
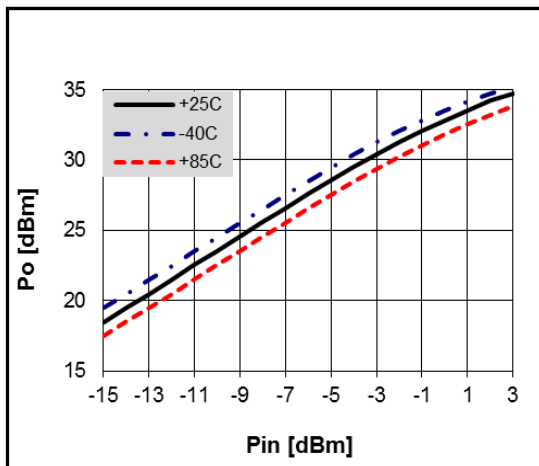
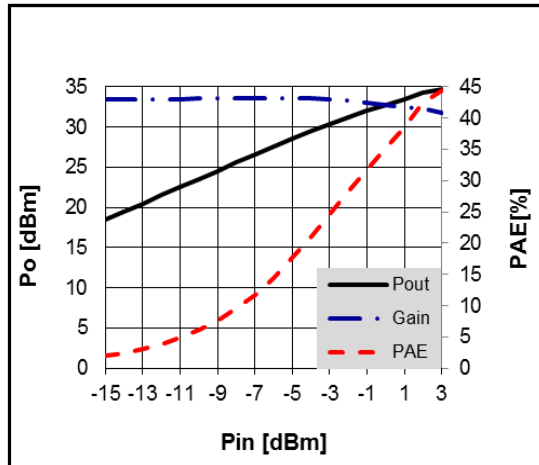
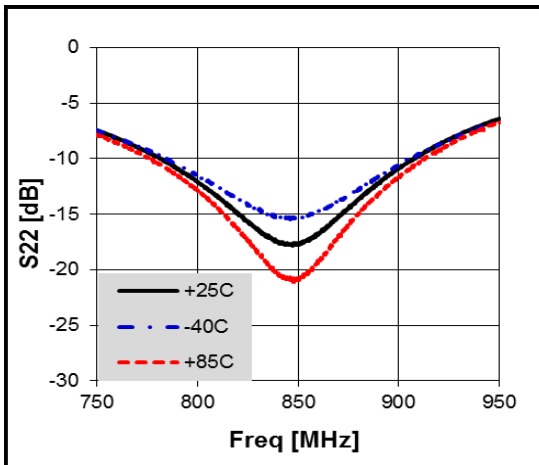
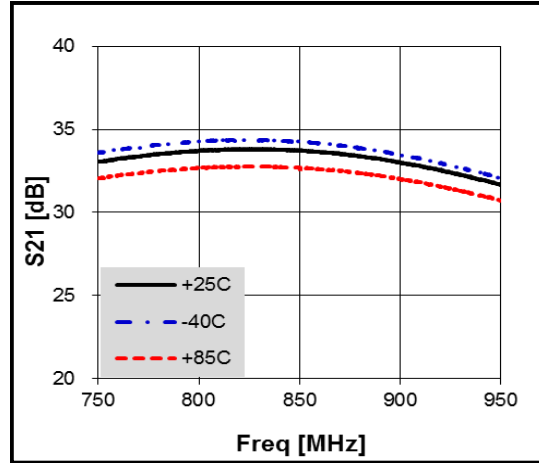
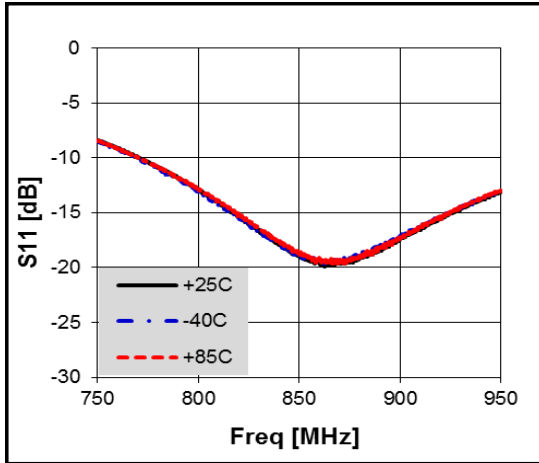
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Preliminary Datasheet

Typical Performance



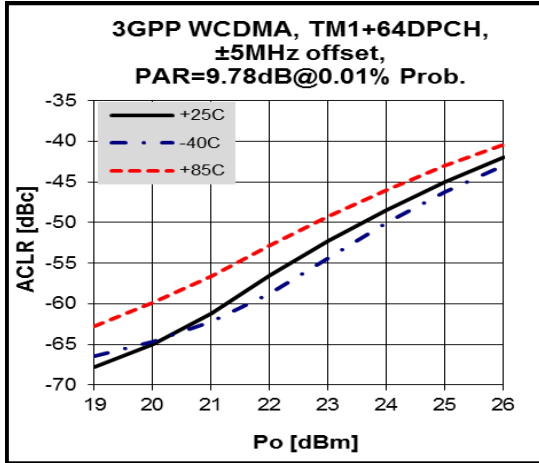
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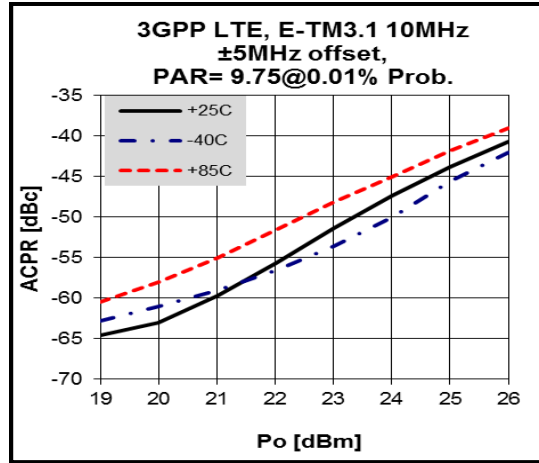


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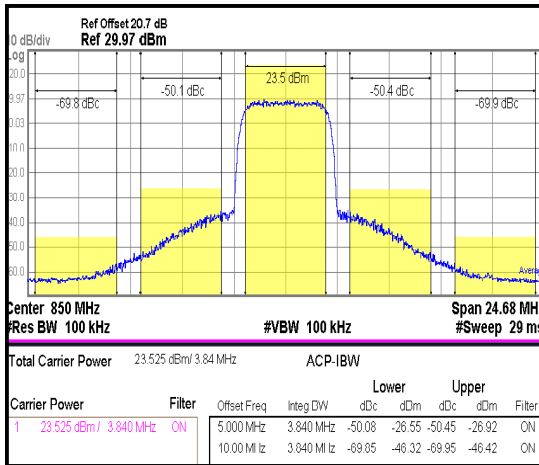
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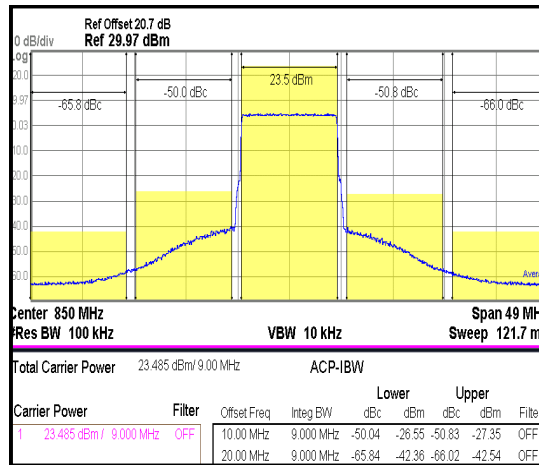
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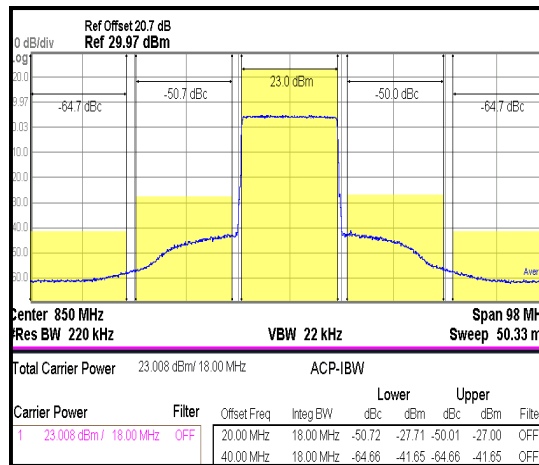
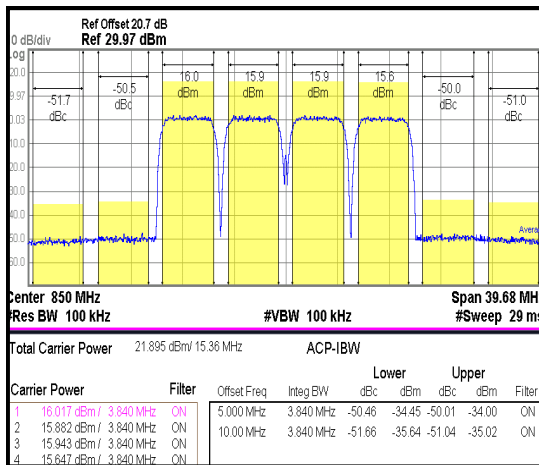
3GPP LTE E-TM3.1 10MHz



3GPP WCDMA TM1 +64DPCH 4FA



3GPP LTE E-TM3.1 20MHz



BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Application Circuit: 1750 MHz

Preliminary Datasheet

Schematic Diagram	BOM	Marks		
	C1	1206	N/A	
	C2	0603	1nF	
	C3	0603	1nF	
	C4	0603	N/A	
	C5	0603	1nF	
	C6	0603	2pF	
	C7	0603	0 Ω	±5%
	C8	0603	3.3pF	
	C9	0603	2.7pF	
	C10	0603	4.3pF	High Q
	C11	0603	3.9pF	
	C12	0603	1uF	
	C13	0603	100pF	
	C14	0603	1nF	
	C15	1206	10uF	Tantalum
L1	0603	N/A		
L2	0603	12nH		
L3	1008	22nH	Coil	
R1	0603	100 Ω	±5%	
R2	0603	270 Ω	±5%	

PCB Diagram	Notice		
<p>BeRex 131126 1750MHz</p> <p>BMT332 EV Board Ver 1.0 Size = 39.3 X 29.5 mm Copper = 1oz.</p> <p>R04003C Er = 3.55 Thk. = 12 mil Width = 0.646 mm Clearance = 0.366 mm</p>	Below information is subject to change as conditions of the substrate.		
	Reference	Object	Distance
	Input pin	C8	5.5mm
	Input pin	C9	4.4mm
	Output pin	C10	2.8mm
	Pin 16	C3	7.2mm
	Pin 16	C6	2.0mm
Pin 19	C5	1.0mm	
Pin 20	C2	10.6mm	
<p>1. Pin 16 & 20 is used for Vce of the inner bias circuit. To eliminate bias line resonance you need above 10mm transmission line and adjust the position of C2, C3, C4, C5 and C6. Also you can adjust spectrum regrowth about bandwidth of signals which you want.</p> <p>2. C10 : We recommend High-Q capacitor for better output power performance. In this document we used '4.3pF(251R14S4R3BV4, EIA 0603) of Johanson Technology.</p> <p>3. C7 : Non-critical 0 Ω.</p>			

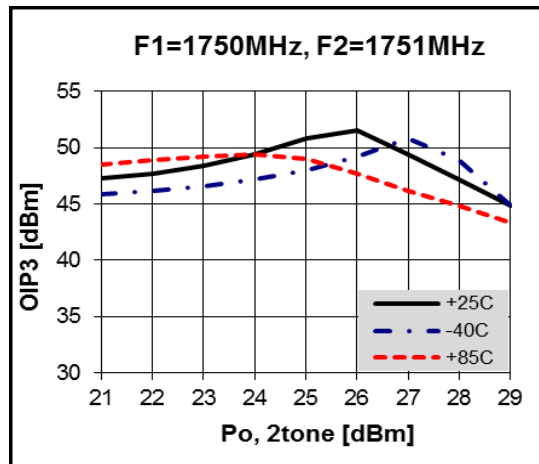
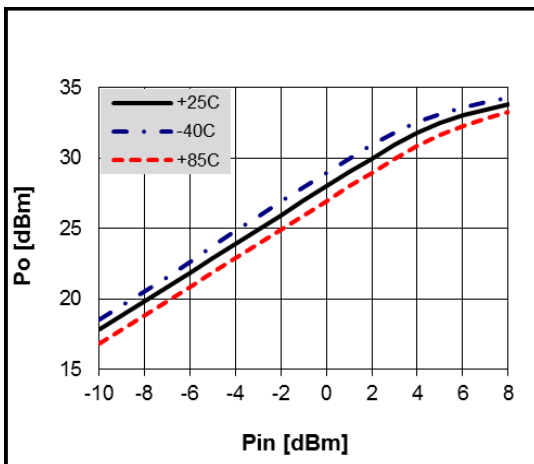
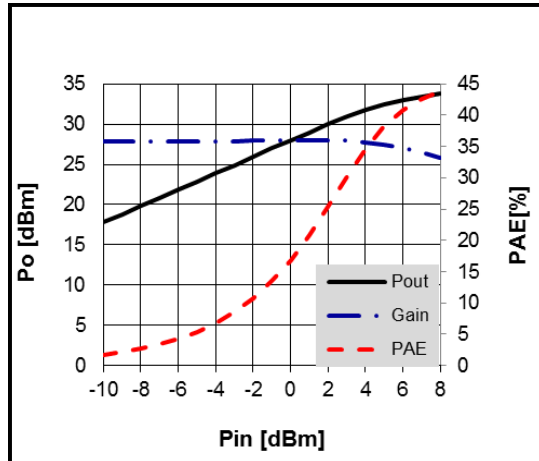
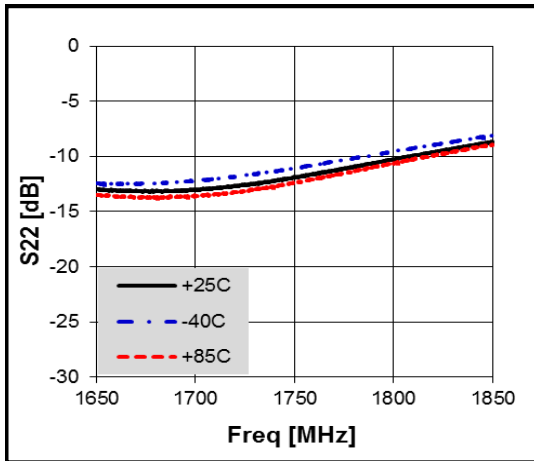
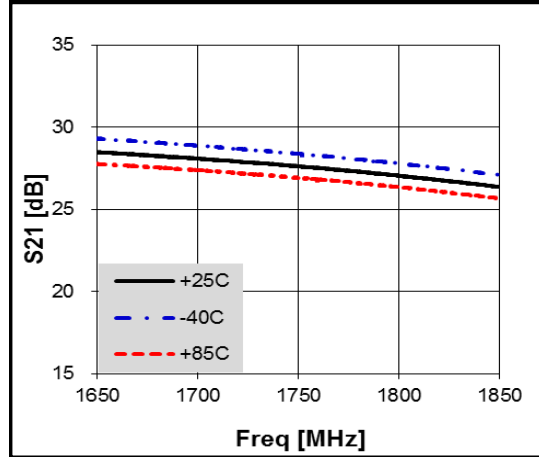
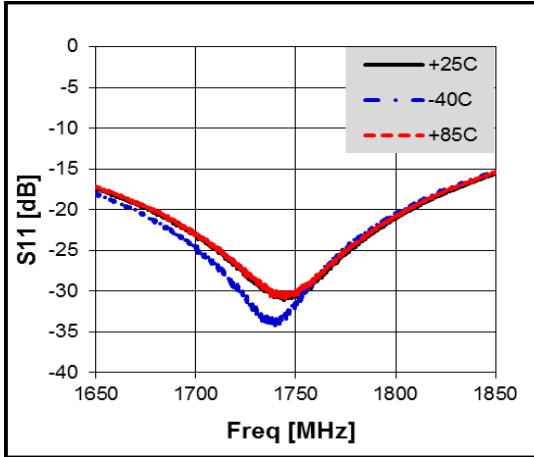
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Typical Performance



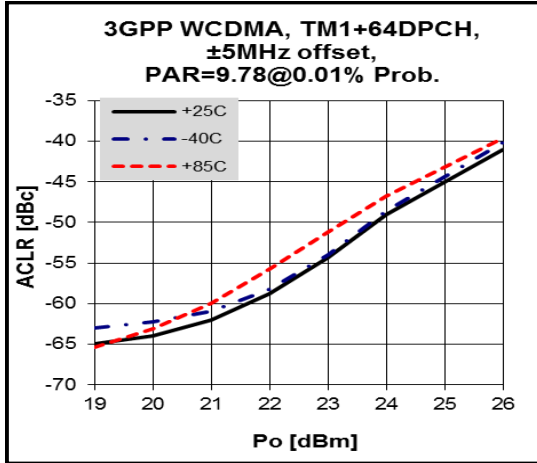
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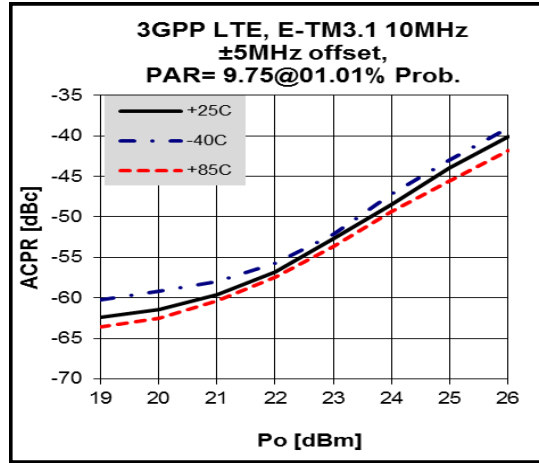


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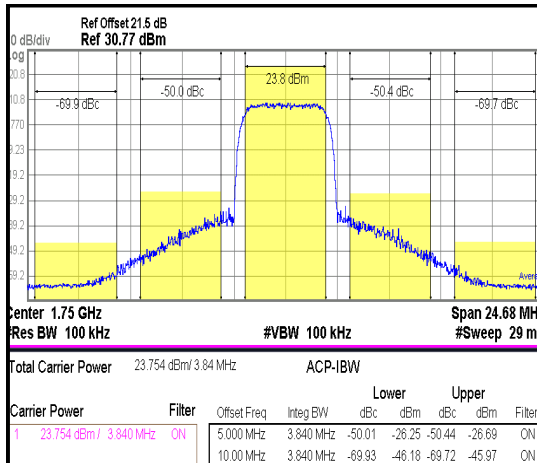
Typical Performance



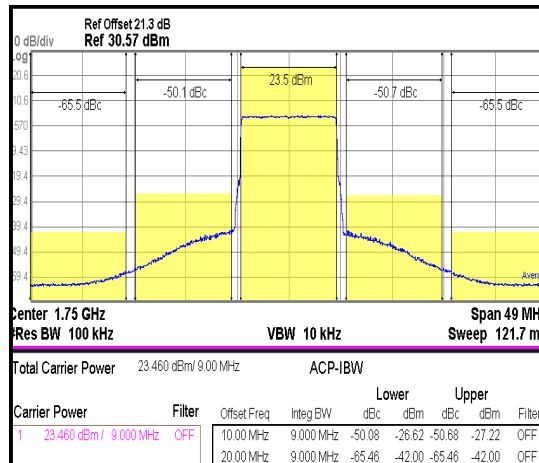
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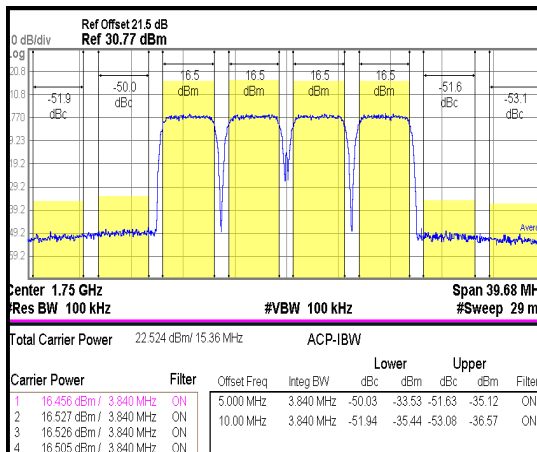
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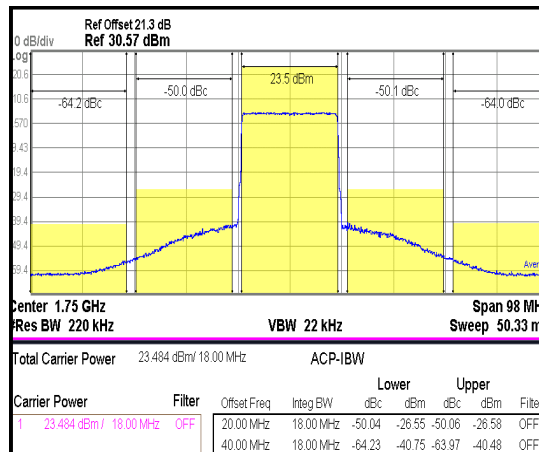
3GPP WCDMA TM1 +64DPCH 4FA



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Application Circuit: 1850 MHz

Preliminary Datasheet

Schematic Diagram	BOM	Marks		
	C1	1206	N/A	
	C2	0603	1nF	
	C3	0603	1nF	
	C4	0603	N/A	
	C5	0603	1nF	
	C6	0603	3pF	
	C7	0603	0 Ω	±5%
	C8	0603	3.3pF	
	C9	0603	2.7pF	
	C10	0603	4.3pF	High Q
	C11	0603	3.9pF	
	C12	0603	1uF	
	C13	0603	100pF	
	C14	0603	1nF	
	C15	1206	10uF	Tantalum
L1	0603	N/A		
L2	0603	12nH		
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R1	0603	100 Ω	±5%	
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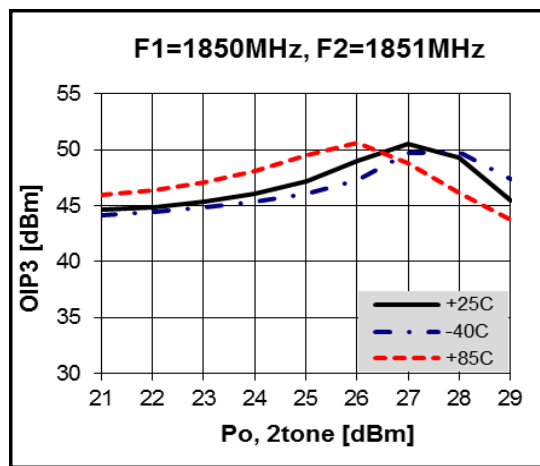
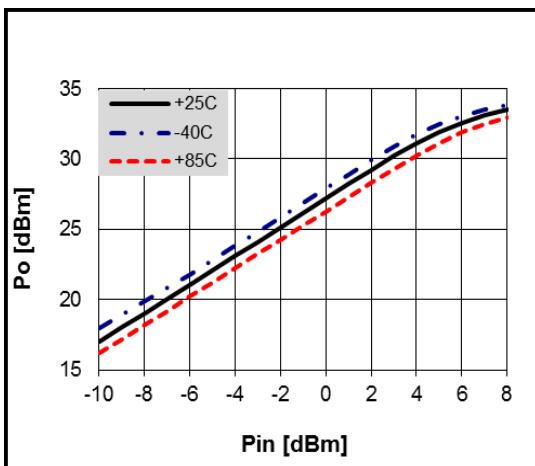
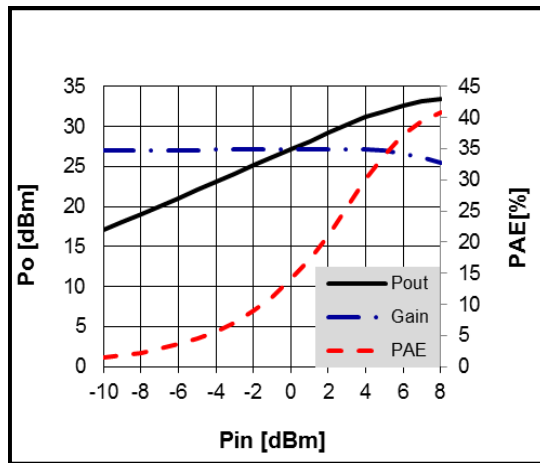
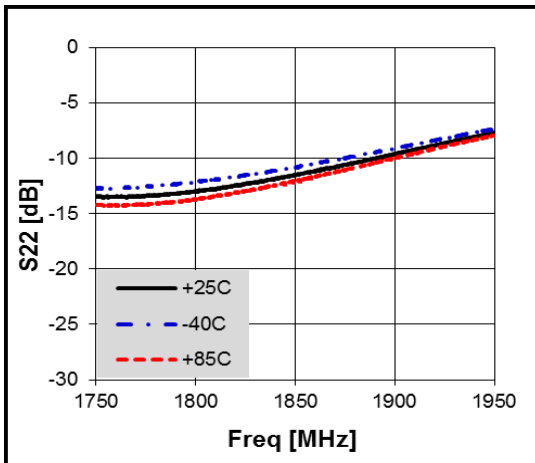
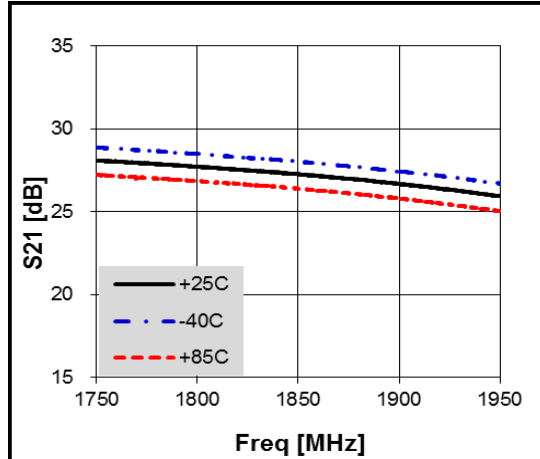
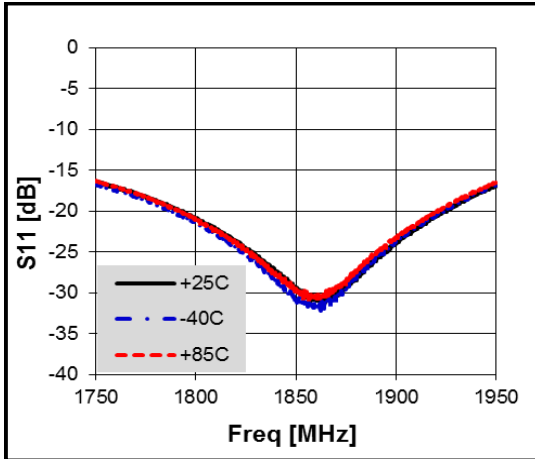
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Typical Performance



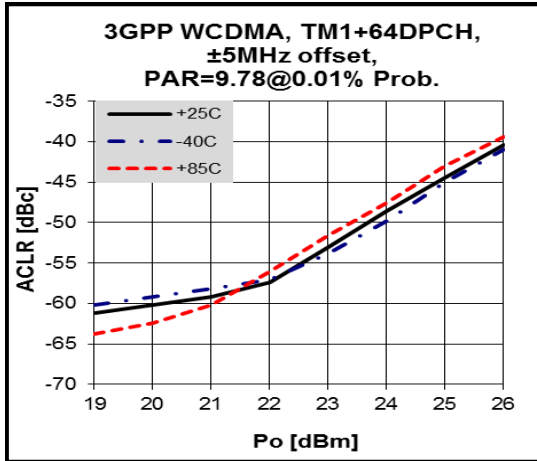
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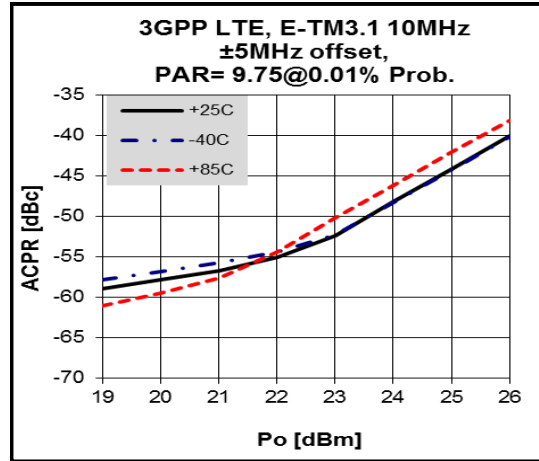


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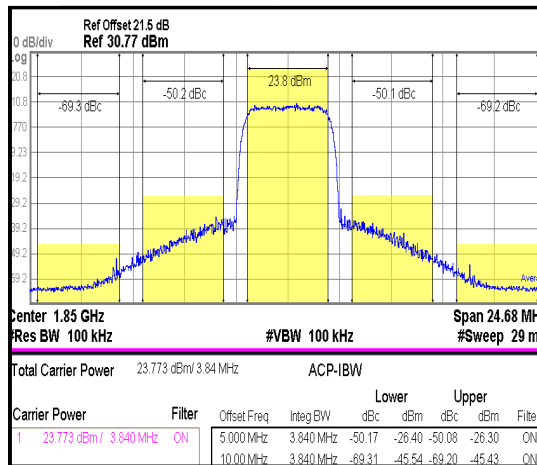
Typical Performance



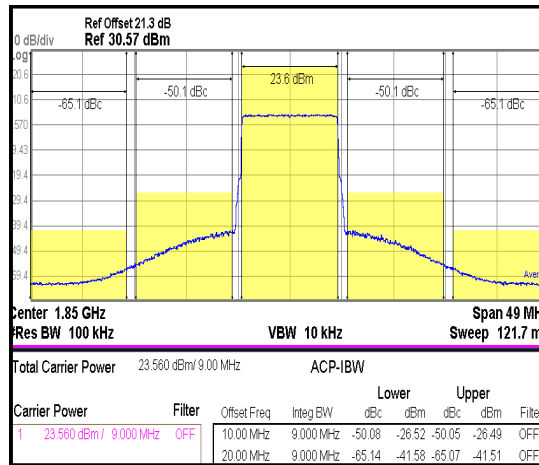
3GPP WCDMA TM1 +64DPCH 1FA



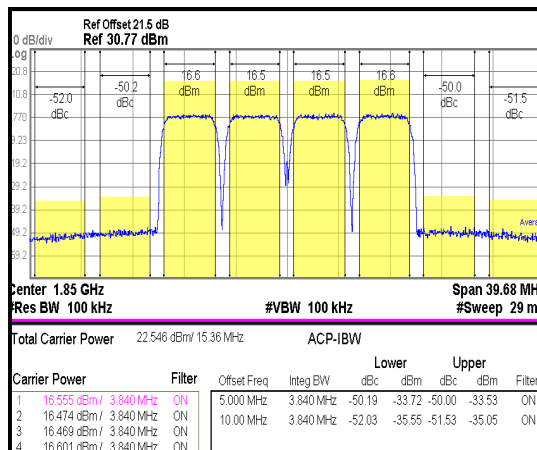
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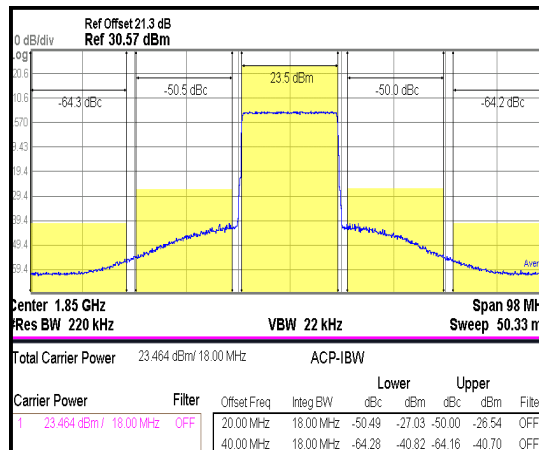
3GPP WCDMA TM1 +64DPCH 4FA



3GPP LTE E-TM3.1 20MHz



3GPP WCDMA TM1 +64DPCH 4FA



3GPP LTE E-TM3.1 20MHz

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Application Circuit: 1960 MHz

Preliminary Datasheet

Schematic Diagram	BOM	Marks	
	C1	1206 N/A	
	C2	0603 1nF	
	C3	0603 1nF	
	C4	0603 N/A	
	C5	0603 1nF	
	C6	0603 2pF	
	C7	0603 0 Ω	±5%
	C8	0603 3.3pF	
	C9	0603 2.7pF	
	C10	0603 4.3pF	High Q
	C11	0603 3.9pF	
	C12	0603 1uF	
	C13	0603 100pF	
	C14	0603 1nF	
	C15	1206 10uF	Tantalum
L1	0603 N/A		
L2	0603 12nH		
L3	1008 12nH	Coil	
R1	0603 100 Ω	±5%	
R2	0603 270 Ω	±5%	

PCB Diagram	Notice																								
	<p>Below information is subject to change as conditions of the substrate.</p> <table border="1"> <thead> <tr> <th>Reference</th> <th>Object</th> <th>Distance</th> </tr> </thead> <tbody> <tr> <td>Input pin</td> <td>C8</td> <td>5.0mm</td> </tr> <tr> <td>Input pin</td> <td>C9</td> <td>3.1mm</td> </tr> <tr> <td>Output pin</td> <td>C10</td> <td>2.0mm</td> </tr> <tr> <td>Pin 16</td> <td>C3</td> <td>5.0mm</td> </tr> <tr> <td>Pin 16</td> <td>C6</td> <td>2.0mm</td> </tr> <tr> <td>Pin 19</td> <td>C5</td> <td>1.0mm</td> </tr> <tr> <td>Pin 20</td> <td>C2</td> <td>10.6mm</td> </tr> </tbody> </table>	Reference	Object	Distance	Input pin	C8	5.0mm	Input pin	C9	3.1mm	Output pin	C10	2.0mm	Pin 16	C3	5.0mm	Pin 16	C6	2.0mm	Pin 19	C5	1.0mm	Pin 20	C2	10.6mm
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	<p>2. C10 : We recommend High-Q capacitor for better output power performance. In this document we used '4.3pF(251R14S4R3BV4, EIA 0603) of Johanson Technology.</p>																								
	<p>3. C7 : Non-critical 0 Ω.</p>																								

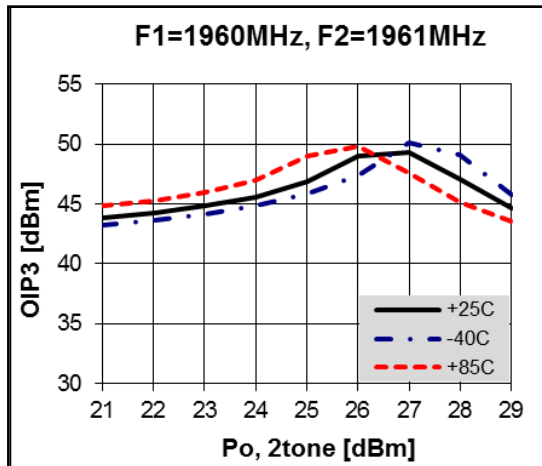
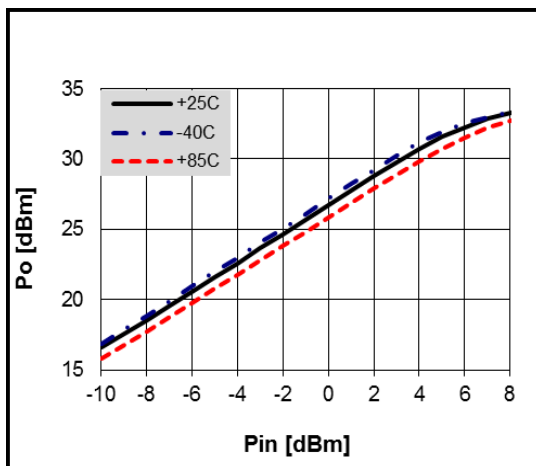
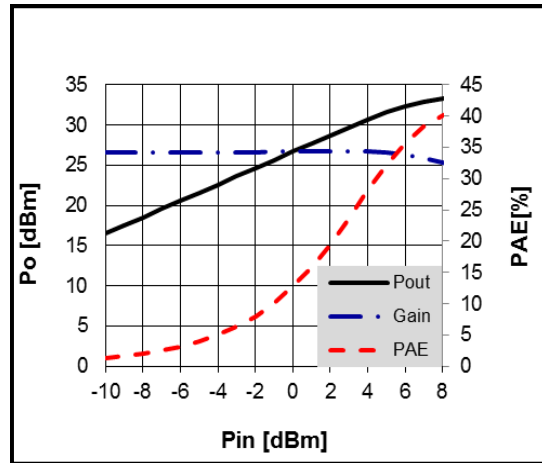
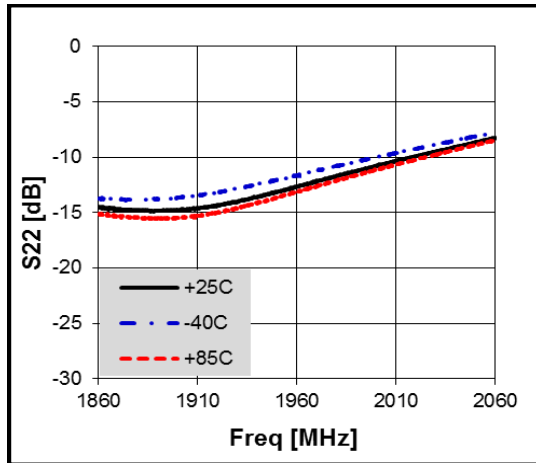
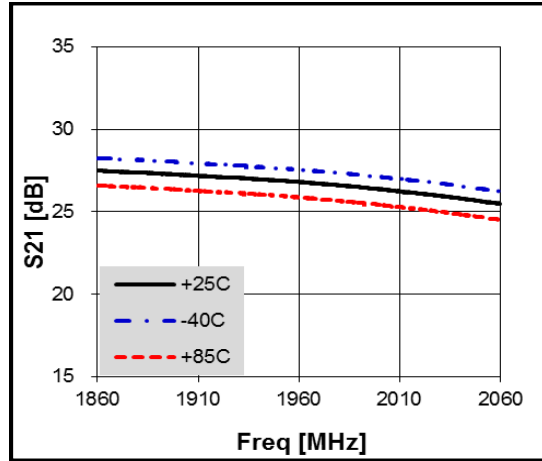
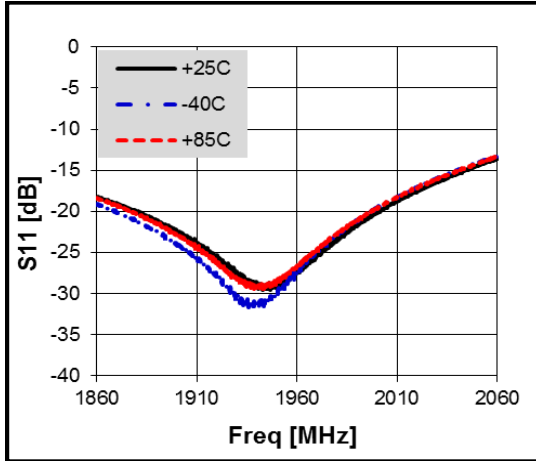
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Preliminary Datasheet

Typical Performance



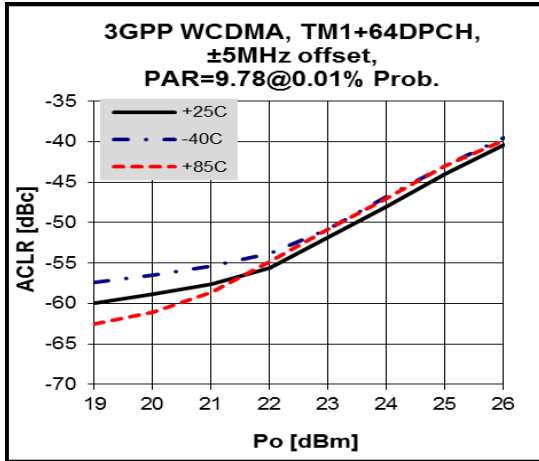
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier

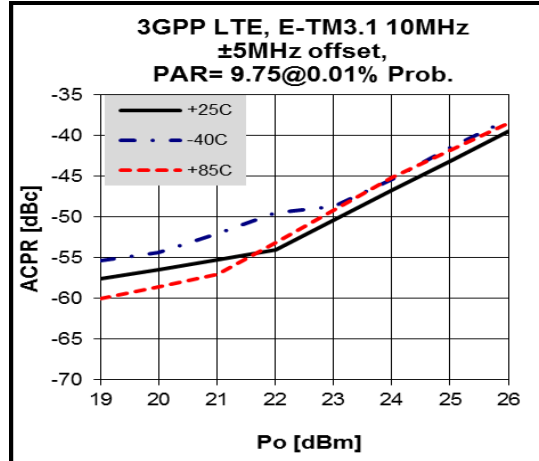


Preliminary Datasheet

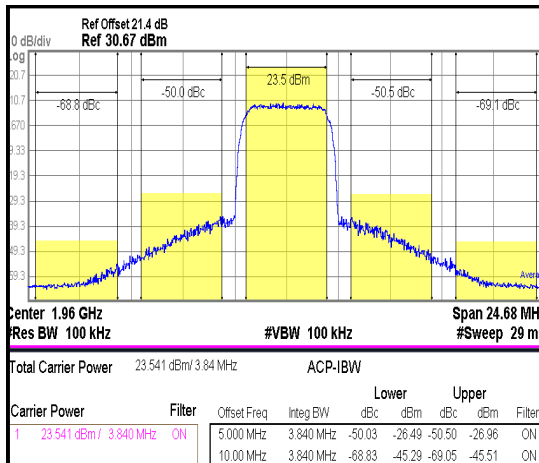
Typical Performance



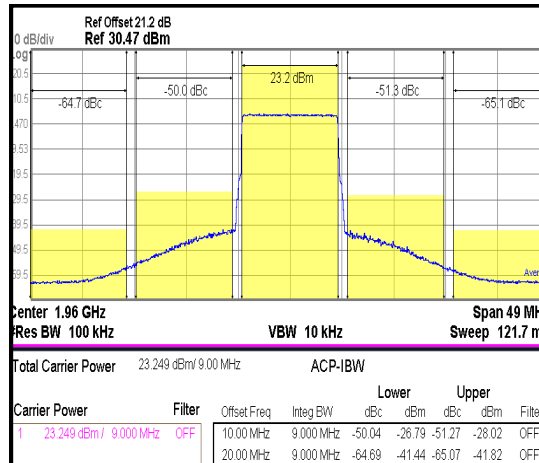
3GPP WCDMA TM1 +64DPCH 1FA



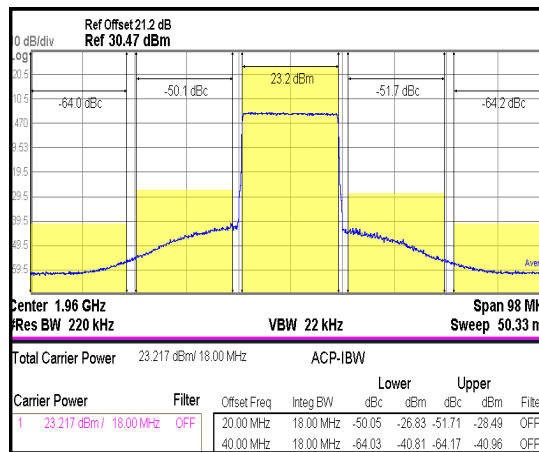
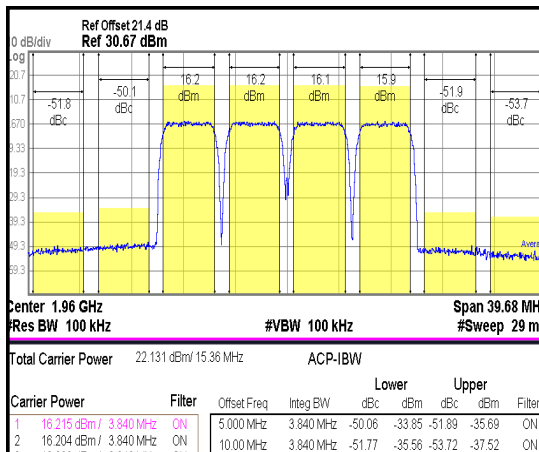
3GPP LTE E-TM3.1 10MHz



3GPP WCDMA TM1 +64DPCH 4FA



3GPP LTE E-TM3.1 20MHz



BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Application Circuit: 2140 MHz

Preliminary Datasheet

Schematic Diagram	BOM	Marks		
	C1	1206 10uF	Tantalum	
	C2	0603	N/A	
	C3	0603	1nF	
	C4	0603	1nF	
	C5	0603	1nF	
	C6	0603	3pF	
	C7	0603	0 Ω	±5%
	C8	0603	3pF	
	C9	0603	2.7pF	
	C10	0603	3.9pF	High Q
	C11	0603	4.3pF	
	C12	0603	1uF	
	C13	0603	100pF	
	C14	0603	1nF	
	C15	1206	10uF	Tantalum
L1	0603	N/A		
L2	0603	12nH		
L3	1008	10nH	Coil	
R1	0603	100 Ω	±5%	
R2	0603	270 Ω	±5%	

PCB Diagram	Notice																								
<p>BeRex 131126 2140MHz</p> <p>BMT332 EV Board Ver 1.0 Size = 39.3 X 29.5 mm Copper = 1oz.</p> <p>R04003C Er = 3.55 Thk. = 12 mil Width = 0.646 mm Clearance = 0.366 mm</p>	<p>Below information is subject to change as conditions of the substrate.</p> <table border="1"> <thead> <tr> <th>Reference</th> <th>Object</th> <th>Distance</th> </tr> </thead> <tbody> <tr> <td>Input pin</td> <td>C8</td> <td>4.1mm</td> </tr> <tr> <td>Input pin</td> <td>C9</td> <td>2.2mm</td> </tr> <tr> <td>Output pin</td> <td>C10</td> <td>1.8mm</td> </tr> <tr> <td>Pin 16</td> <td>C3</td> <td>3.0mm</td> </tr> <tr> <td>Pin 16</td> <td>C6</td> <td>2.0mm</td> </tr> <tr> <td>Pin 19</td> <td>C5</td> <td>1.0mm</td> </tr> <tr> <td>Pin 20</td> <td>C4</td> <td>5.0mm</td> </tr> </tbody> </table>	Reference	Object	Distance	Input pin	C8	4.1mm	Input pin	C9	2.2mm	Output pin	C10	1.8mm	Pin 16	C3	3.0mm	Pin 16	C6	2.0mm	Pin 19	C5	1.0mm	Pin 20	C4	5.0mm
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	<p>2. C10 : We recommend High-Q capacitor for better output power performance. In this document we used '3.9pF(251R14S3R9BV4, EIA 0603) of Johanson Technology.</p>																								
	<p>3. C7 : Non-critical 0 Ω.</p>																								

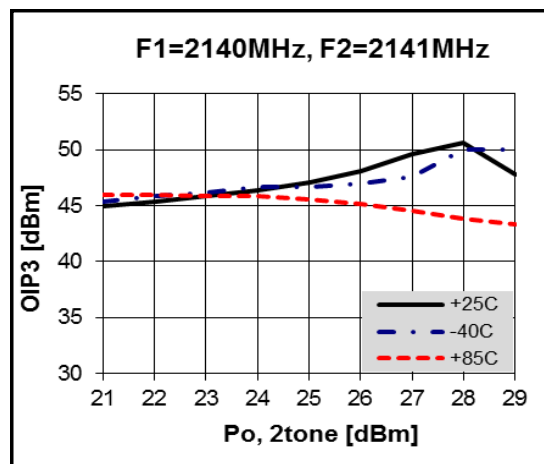
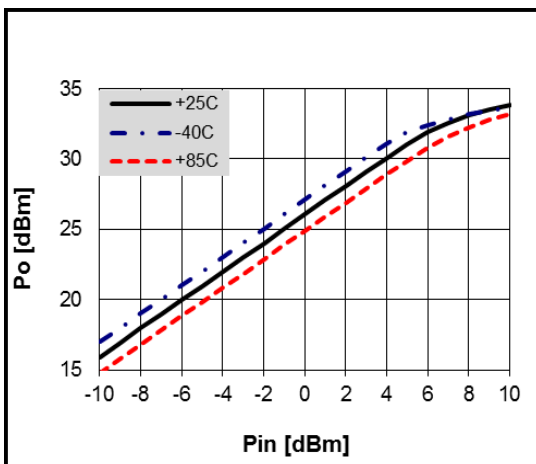
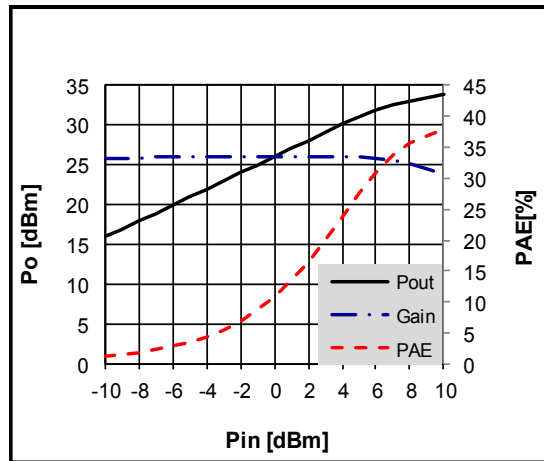
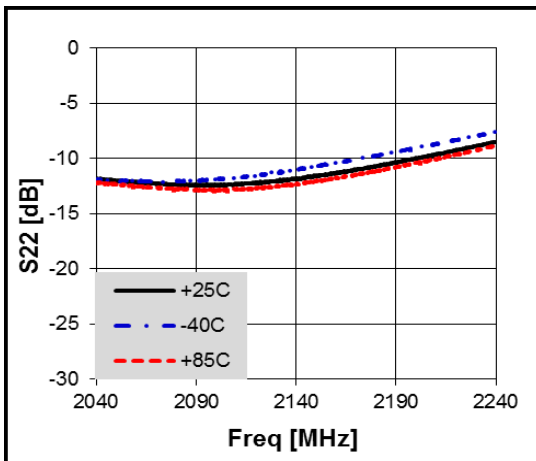
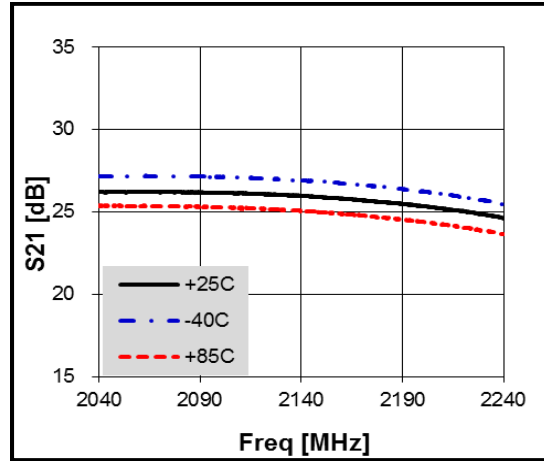
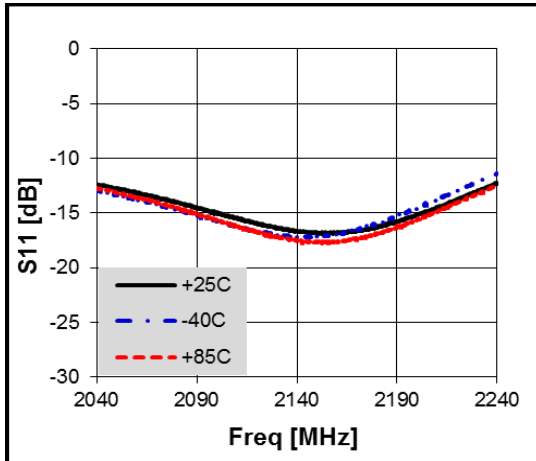
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Preliminary Datasheet

Typical Performance



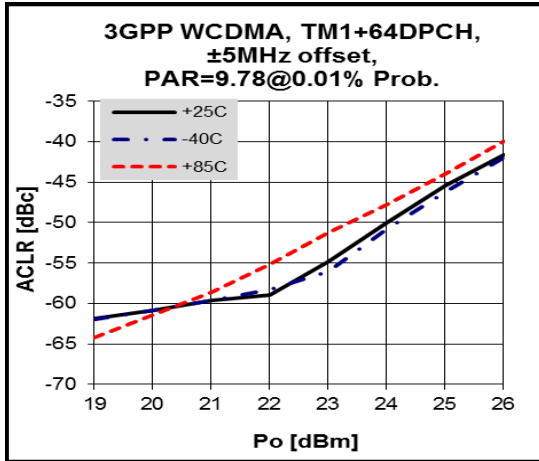
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier

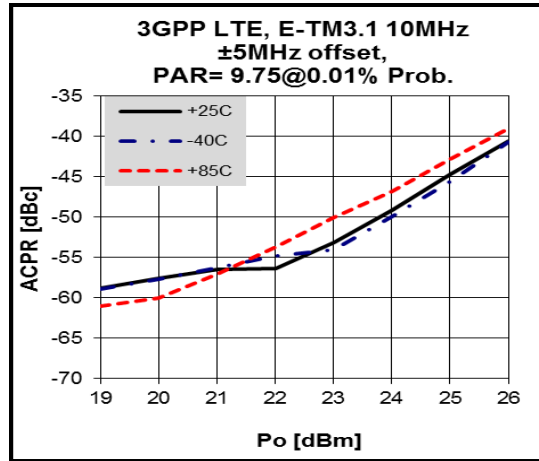


Preliminary Datasheet

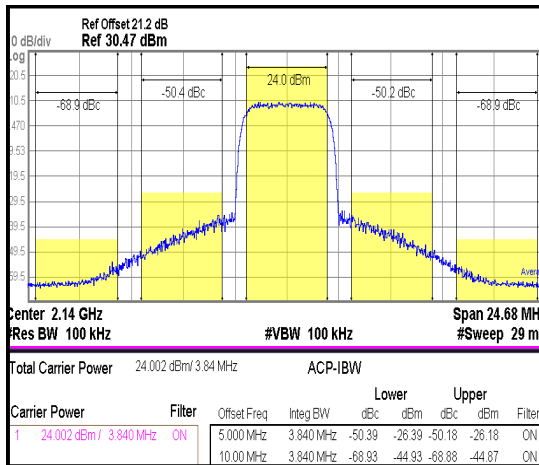
Typical Performance



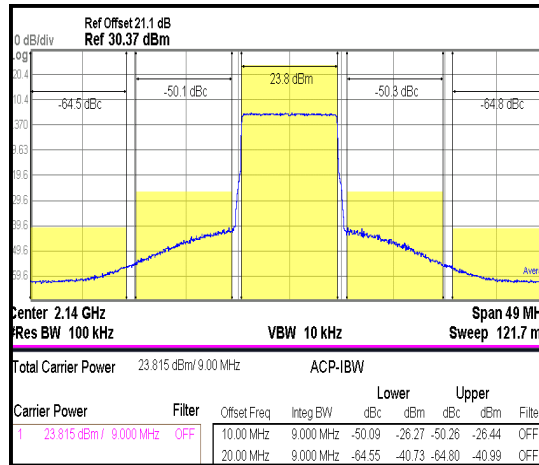
3GPP WCDMA TM1 +64DPCH 1FA



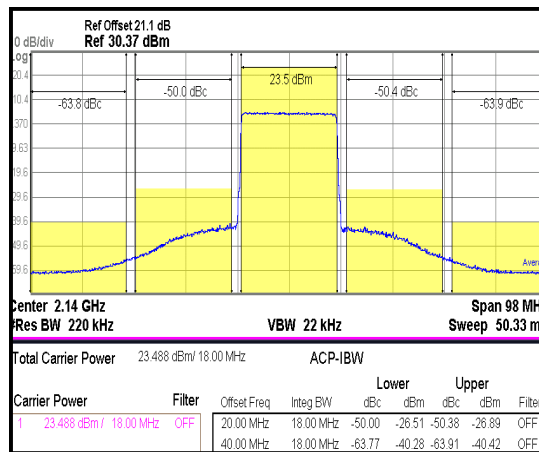
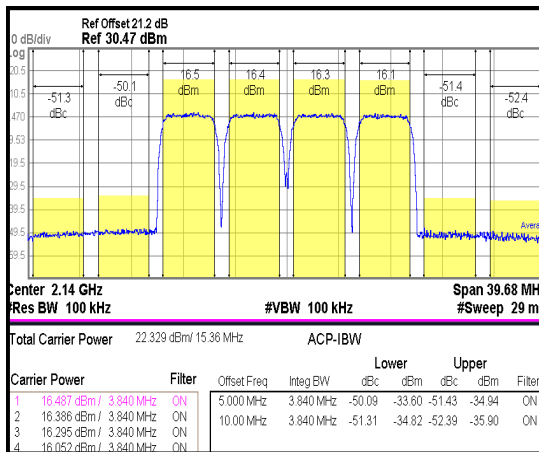
3GPP LTE E-TM3.1 10MHz



3GPP WCDMA TM1 +64DPCH 4FA



3GPP LTE E-TM3.1 20MHz



BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Application Circuit: 2350 MHz

Preliminary Datasheet

Schematic Diagram	BOM	Marks		
	C1	1206 10uF	Tantalum	
	C2	0603	N/A	
	C3	0603	N/A	
	C4	0603	0.75pF	
	C5	0603	1nF	
	C6	0603	1nF	
	C7	0603	0 Ω	±5%
	C8	0603	2.2pF	
	C9	0603	2.7pF	
	C10	0603	3.3pF	High Q
	C11	0603	22pF	
	C12	0603	1uF	
	C13	0603	100pF	
	C14	0603	1nF	
	C15	1206	10uF	Tantalum
L1	0603	N/A		
L2	0603	15nH		
L3	1008	10nH	Coil	
R1	0603	100 Ω	±5%	
R2	0603	270 Ω	±5%	

PCB Diagram	Notice																					
<p>BeRex 131126 2350MHz</p> <p>BMT332 EV Board Ver 1.0 Size = 39.3 X 29.5 mm Copper = 1oz.</p> <p>R04003C Er = 3.55 Thk. = 12 mil Width = 0.646 mm Clearance = 0.366 mm</p>	<p>Below information is subject to change as conditions of the substrate.</p> <table border="1"> <thead> <tr> <th>Reference</th> <th>Object</th> <th>Distance</th> </tr> </thead> <tbody> <tr> <td>Input pin</td> <td>C8</td> <td>3.6mm</td> </tr> <tr> <td>Input pin</td> <td>C9</td> <td>0.6mm</td> </tr> <tr> <td>Output pin</td> <td>C10</td> <td>1.3mm</td> </tr> <tr> <td>Pin 16</td> <td>C6</td> <td>2.0mm</td> </tr> <tr> <td>Pin 19</td> <td>C5</td> <td>1.0mm</td> </tr> <tr> <td>Pin 20</td> <td>C4</td> <td>5.0mm</td> </tr> </tbody> </table> <p>1. Pin 16 & 20 is used for Vce of the inner bias circuit. To eliminate bias line resonance you need above 10mm transmission line and adjust the position of C2, C3, C4, C5 and C6. Also you can adjust spectrum regrowth about bandwidth of signals which you want.</p> <p>2. C10 : We recommend High-Q capacitor for better output power performance. In this document we used '3.3pF(251R14S3R3BV4, EIA 0603) of Johanson Technology.</p> <p>3. C7 : Non-critical 0 Ω.</p>	Reference	Object	Distance	Input pin	C8	3.6mm	Input pin	C9	0.6mm	Output pin	C10	1.3mm	Pin 16	C6	2.0mm	Pin 19	C5	1.0mm	Pin 20	C4	5.0mm
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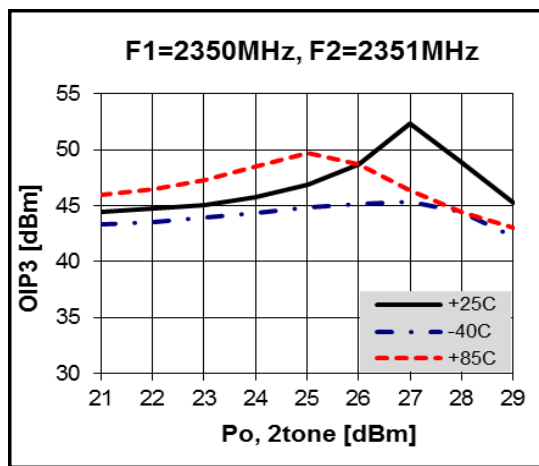
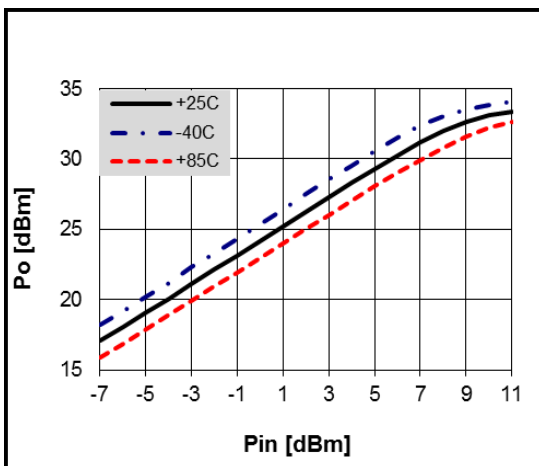
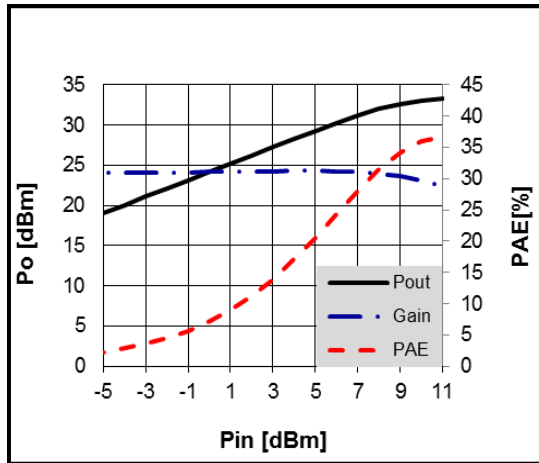
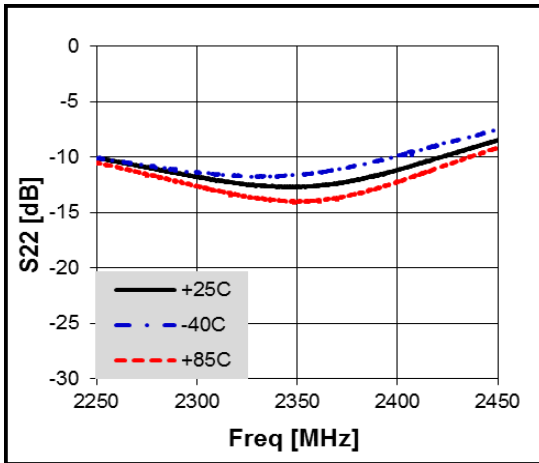
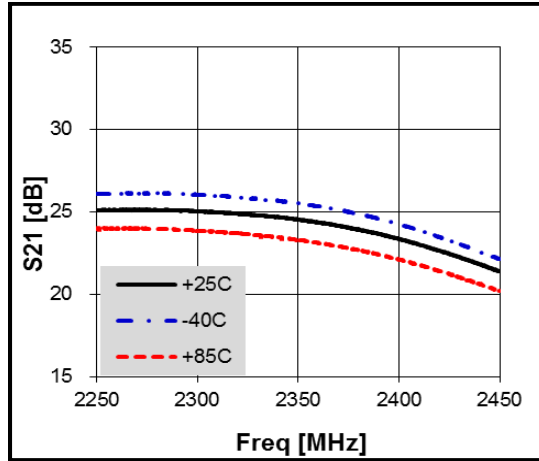
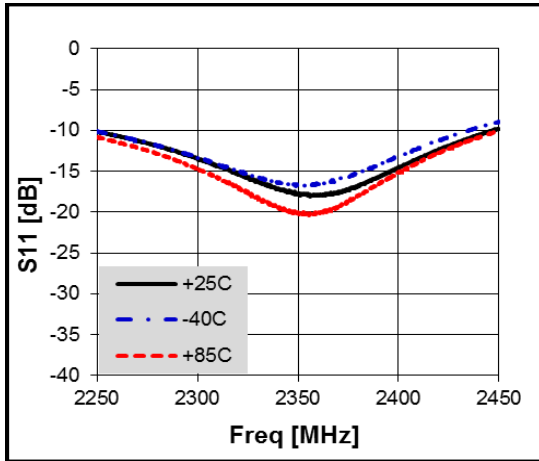
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Preliminary Datasheet

Typical Performance



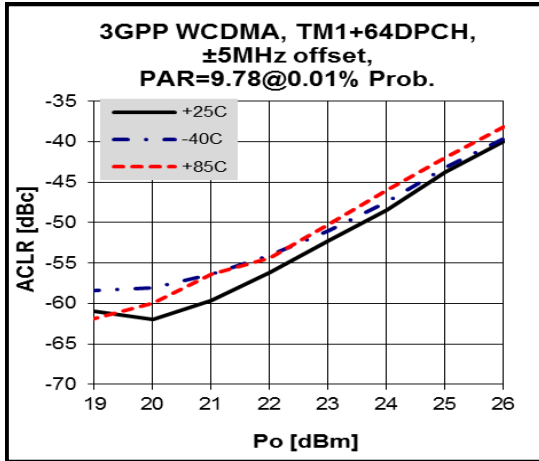
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier

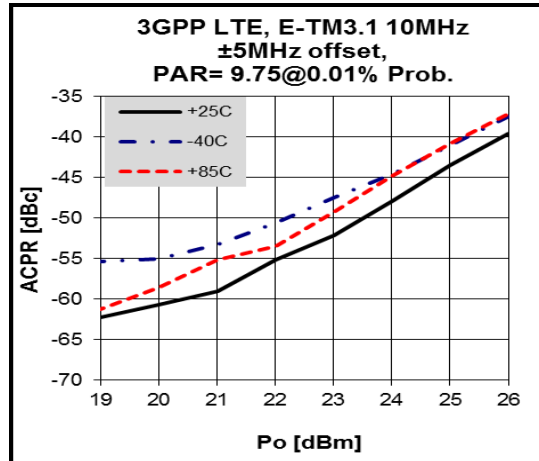


Preliminary Datasheet

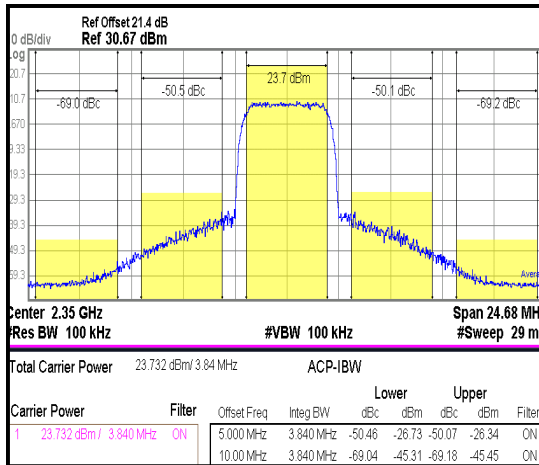
Typical Performance



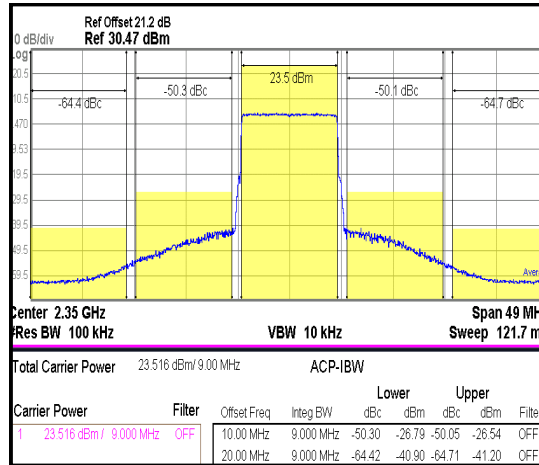
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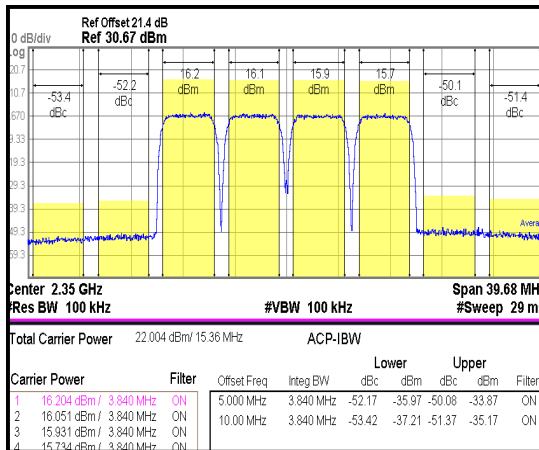
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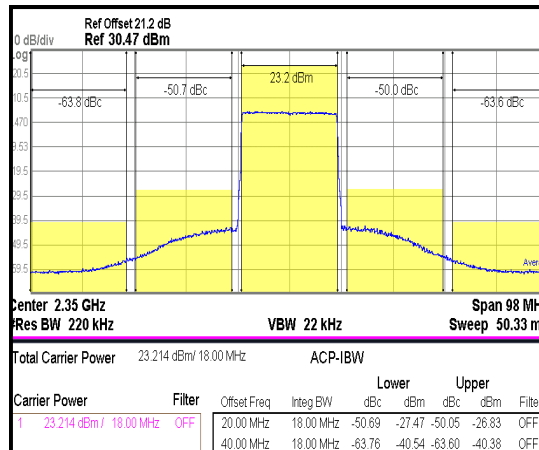
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3GPP LTE E-TM3.1 20MHz



3GPP WCDMA TM1 +64DPCH 4FA



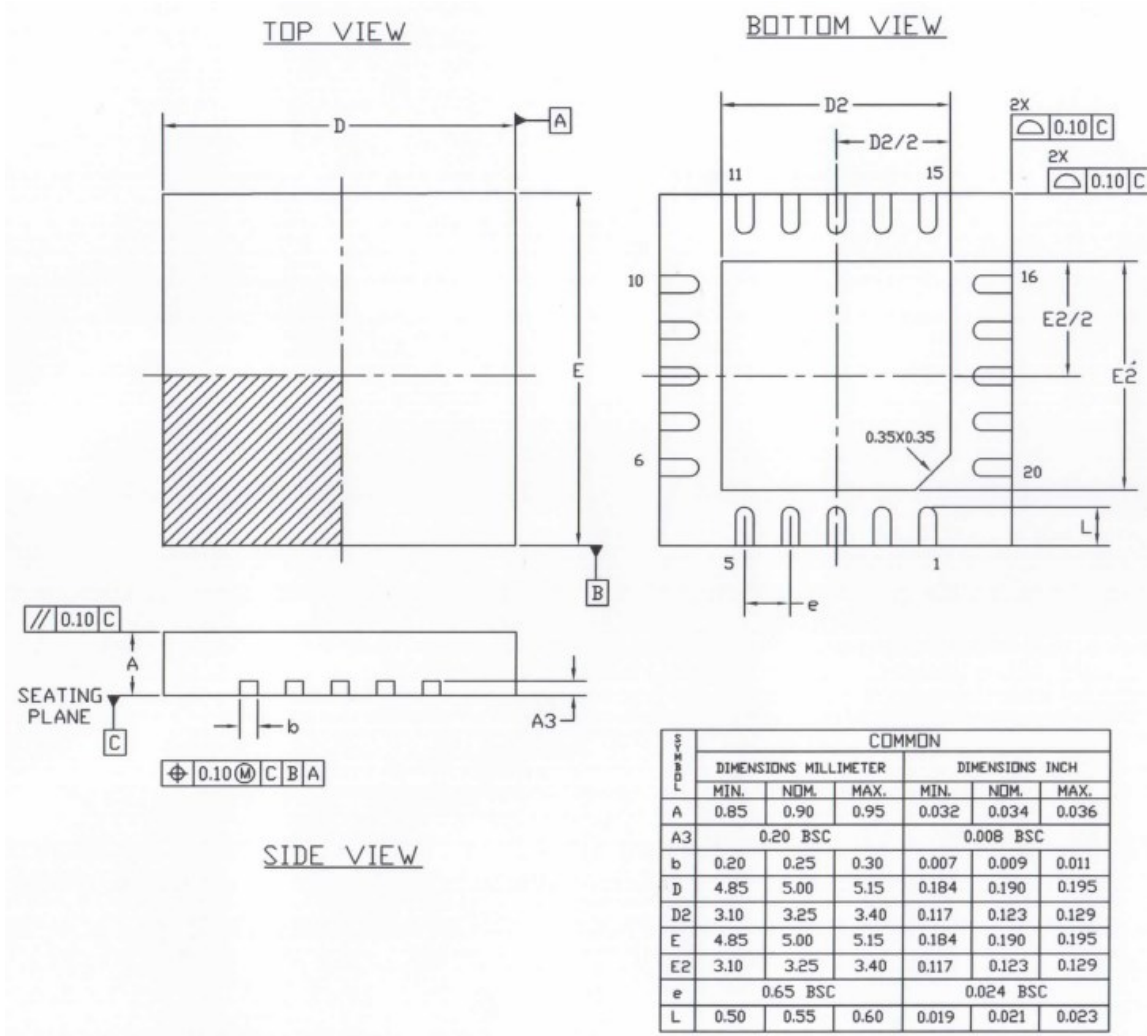
3GPP LTE E-TM3.1 20MHz

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Package Outline Dimension



NOTES :

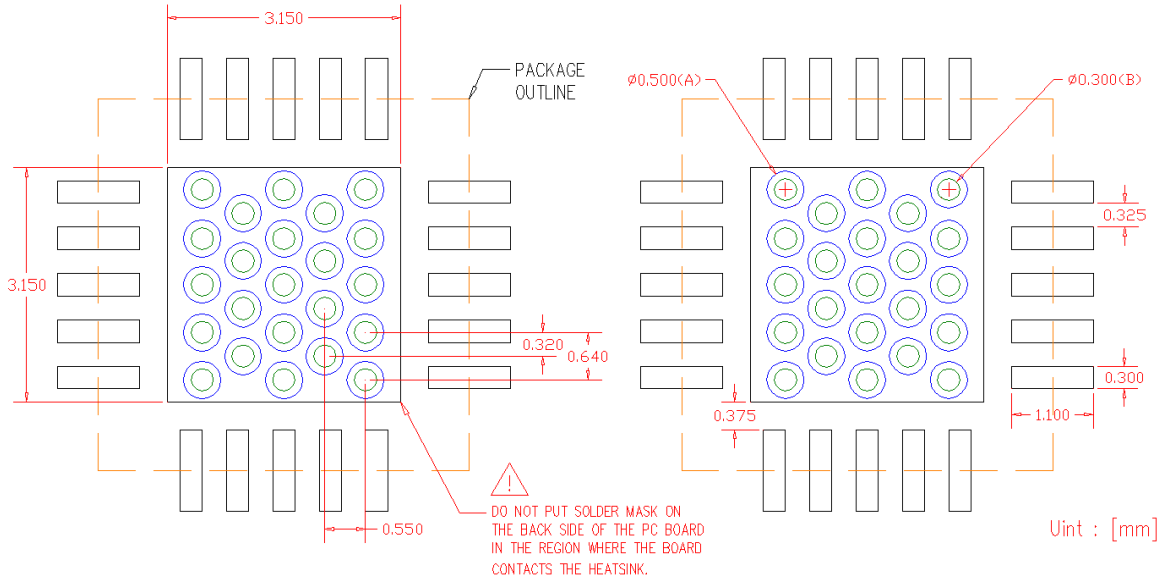
1. DIMENSION AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. CONTROLLING DIMENSIONS : MILLIMETER. CONVERTED INCH DIMENSION ARE NOT NECESSARILY EXACT.
3. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM. FROM TERMINAL TIP.
4. INSULATION THICKNESS, CLEARANCE OF OVERLAP ARE USER DEFINED.
5. INSULATION NOT COMPLETELY SHOWN FOR REASONS OF CLARITY.

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



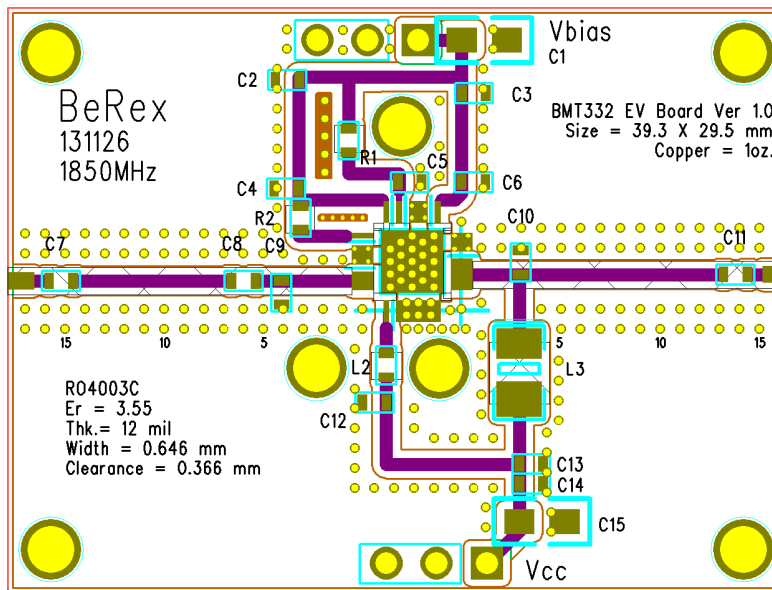
Suggested PCB Land Pattern and PAD Layout



Notes

1. Use 1 oz. copper minimum for top and bottom layer metal.
2. A heatsink underneath the area of the PCB for the mounted device is required for proper thermal operation.
3. Ground / thermal vias are critical for the proper performance of this device.

Vias should use a 0.5 mm(A) diameter drill and have a final plated thru diameter of 0.3 mm(B).



Preliminary Datasheet

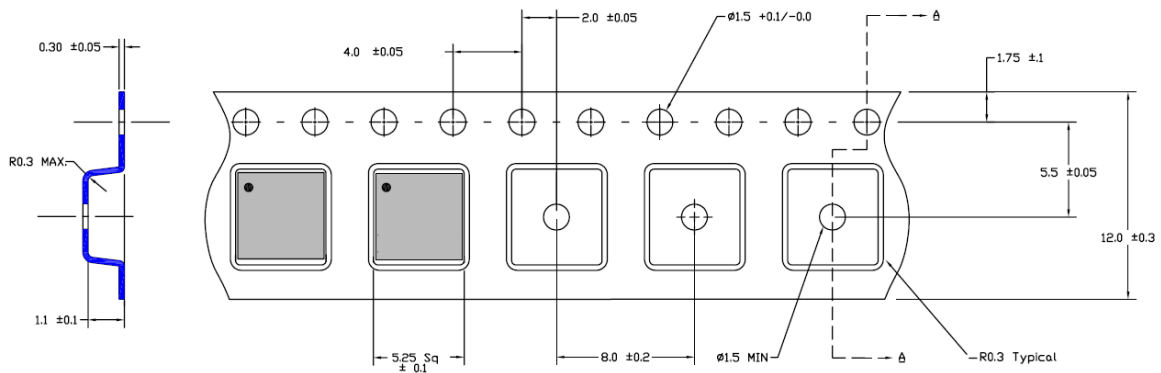
BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Tape & Reel

QFN 5x5



Packaging information :

Tape width(mm) : 12

Reel Size (inches) : 7

Device Cavity Pitch(mm) : 8

Devices Per Reel : 1000

Lead plating finish

100% Tin Matte finish

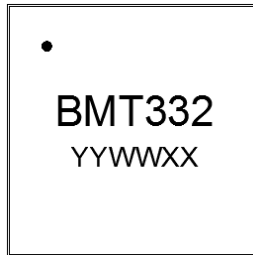
(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

BMT332

700-2400 MHz 2W High Linearity 5V 2-Stage Power Amplifier



Package Marking



YY = Year, WW = Working Week,
XX = Wafer No.

MSL / ESD Rating

ESD Rating:	Class 1C
Value:	Passes $\geq 1000V$ to $< 2000 V$
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114B
ESD Rating:	Class C3
Value:	Passes $>1000V$
Test:	Charged Device Model (CDM)
Standard:	JEDEC Standard JESD22-C101F
MSL Rating:	Level 1 at $+260^{\circ}C$ convection reflow
Standard:	JEDEC Standard J-STD-020

NATO CAGE code:

2	N	9	6	F
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